

# **HD74HCT238**

# 3-to-8-line Decoder/Demultiplexer

REJ03D0661-0200 (Previous ADE-205-549) Rev.2.00 Mar 30, 2006

#### **Description**

The HD74HCT238 has 3 binary select inputs (A, B, and C). If the device is enabled these inputs determined which one of the eight normally high outputs will go low. Two active low and one active high enables  $(G_1, \overline{G_{2A}})$  and  $\overline{G_{2B}}$  are provided to ease the cascading of decoders.

#### **Features**

• High Speed Operation:  $t_{pd}$  (A, B, C to Y) = 16.5 ns typ ( $C_L = 50 \text{ pF}$ )

• High Output Current: Fanout of 10 LSTTL Loads

• Wide Operating Voltage:  $V_{CC} = 2 \text{ V}$  to 6 V

• Low Input Current: 1 µA max

• Low Quiescent Supply Current:  $I_{CC}$  (static) = 4  $\mu$ A max (Ta = 25°C)

• Ordering Information

Part Name	Package Type Package Code (Previous Code)		Package Abbreviation	Taping Abbreviation (Quantity)	
HD74HCT238FPEL	SOP-16 pin (JEITA)	PRSP0016 DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)	
HD74HCT238RPEL	SOP-16 pin (JEDEC)	PRSP0016 DG-A (FP-16DNV)	RP	EL (2,500 pcs/reel)	

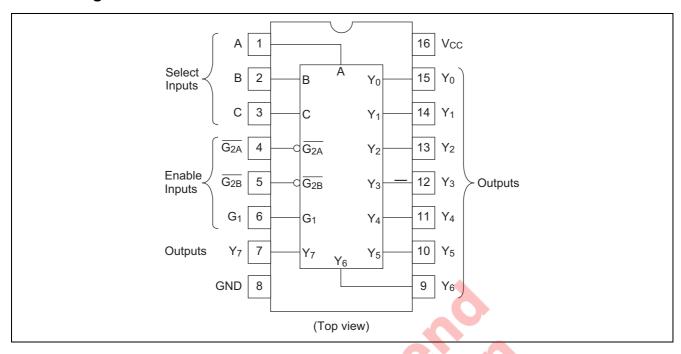
Note: Please consult the sales office for the above package availability.

#### **Function Table**

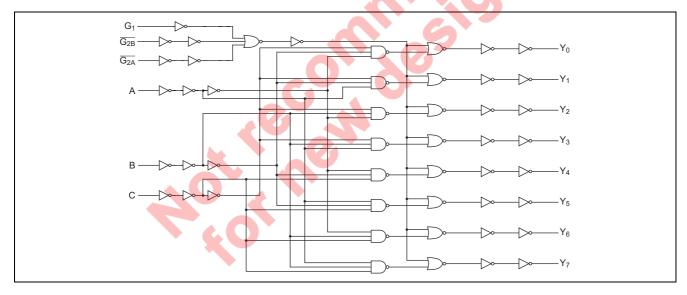
		Inp	uts			Outputs							
	Enable			Select			Ουτρατό						
G <sub>1</sub>	G <sub>2A</sub>	G <sub>2B</sub>	C	В	Α	Y <sub>0</sub>	Y <sub>1</sub>	Y <sub>2</sub>	Y <sub>3</sub>	Y <sub>4</sub>	<b>Y</b> <sub>5</sub>	Y <sub>6</sub>	Y <sub>7</sub>
Х	Х	Н	X	X	X	L	L	L	L	L	L	L	L
Х	Н	Х	X	X	Χ	L	L	L	L	L	L	L	L
L	Х	Х	X	Χ	Χ	L	L	L	L	L	L	L	L
Н	L	L	L	L	L	Н	L	L	L	L	L	L	L
Н	L	L	L	L	Н	L	Н	L	L	L	L	L	L
Н	L	L	L	Н	L	L	L	Н	L	L	L	L	L
Н	L	L	L	Н	Н	L	L	L	Н	L	L	L	L
Н	L	L	Н	L	L	L	L	L	L	Н	L	L	L
Н	L	L	Н	L	Н	L	L	L	L	L	Н	L	L
Н	L	L	Н	Н	L	L	L	L	L	L	L	Н	L
Н	L	L	Н	Н	Н	L	L	L	L	L	L	L	Н

H: High levelL: Low levelX: Irrelevant

### **Pin Arrangement**



# **Logic Diagram**



# **Absolute Maximum Ratings**

Item	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to +7.0	V
Input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Output voltage	V <sub>OUT</sub>	$-0.5$ to $V_{CC}$ + 0.5	V
Output current	I <sub>OUT</sub>	±25	mA
DC current drain per V <sub>CC</sub> , GND	I <sub>CC</sub> , I <sub>GND</sub>	±50	mA
DC input diode current	I <sub>IK</sub>	±20	mA
DC output diode current	Іок	±20	mA
Power dissipation per package	P <sub>T</sub>	500	mW
Storage temperature	Tstg	-65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

# **Recommended Operating Conditions**

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V <sub>CC</sub>	4.5 to 5.5	V	
Input / Output voltage	V <sub>IN</sub> , V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	Та	-40 to 85	°C	
Input rise / fall time*1	t <sub>r</sub> , t <sub>f</sub>	0 to 500	ns	V <sub>CC</sub> = 4.5 V

Notes: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

#### **Electrical Characteristics**

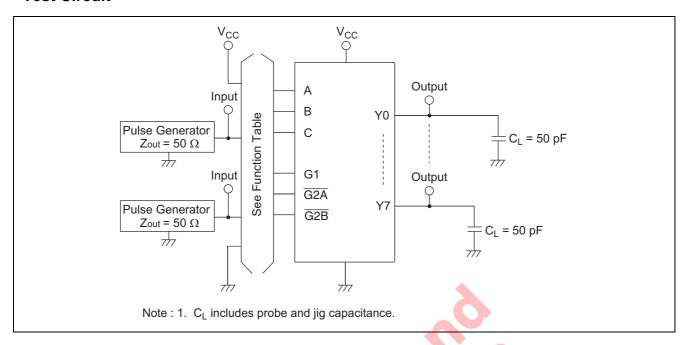
Item	Symbol	V <sub>cc</sub> (V)	Ta = 25°C			Ta = -40	to+85°C	Unit	Test Conditions	
item		ACC (A)	Min	Тур	Max	Min	Max	Offic	lest con	uitions
Input voltage	V <sub>IH</sub>	4.5 to 5.5	2.0	_	_	2.0	_	V		
	$V_{IL}$	4.5 to 5.5	_	_	0.8	_	0.8	V		
Output voltage	V <sub>OH</sub>	4.5	4.4	_	_	4.4	_	V	$Vin = V_{IH} or V_{IL}$	$I_{OH} = -20 \mu A$
		4.5	4.18	_	_	4.13				$I_{OH} = -4 \text{ mA}$
	V <sub>OL</sub>	4.5	_	_	0.1	_	0.1	V	$Vin = V_{IH} or V_{IL}$	$I_{OL} = 20 \mu A$
		4.5	_	_	0.26	_	0.33	5		I <sub>OL</sub> = 4 mA
Input current	lin	5.5	_	_	±0.1	_	±1.0	μΑ	$Vin = V_{CC} \text{ or } GN$	D
Quiescent supply	Icc	5.5	_	_	4.0	_	40	μΑ	$Vin = V_{CC}$ or $GN$	D, lout = $0 \mu A$
current										

# **Switching Characteristics**

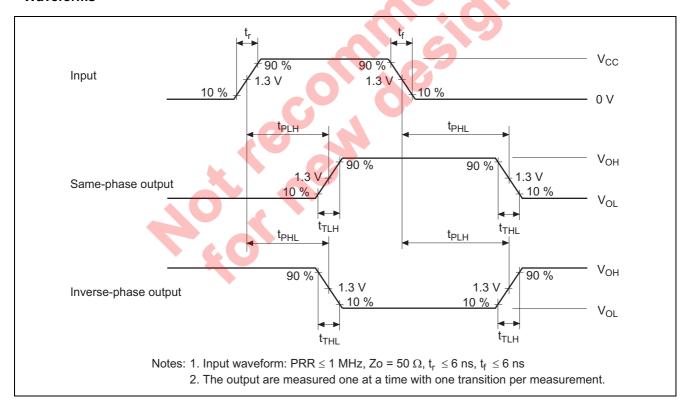
 $(C_L = 50 \text{ pF}, Input t_r = t_f = 6 \text{ ns})$ 

lt and	Symbol	V <sub>cc</sub> (V)	T	a = 25°	C	$Ta = -40 \text{ to } +85^{\circ}\text{C}$		I I m ! £	Took Conditions
Item			Min	Тур	Max	Min	Max	Unit	Test Conditions
Propagation delay time	t <sub>PLH</sub>	4.5		18	30	1	38	ns	A, B or C to Y
	t <sub>PHL</sub>	4.5	7	19	30	_	38		
	t <sub>PLH</sub>	4.5	) [	17	30	_	38	ns	G <sub>2A</sub> to Y
	t <sub>PHL</sub>	4.5	İ	17	30	_	39		
	t <sub>PLH</sub>	4.5	T	17	30	_	38	ns	G <sub>2B</sub> to Y
	t <sub>PHL</sub>	4.5		17	30	_	38		
	t <sub>PLH</sub>	4.5	J	17	30	_	38	ns	G₁ to Y
	t <sub>PHL</sub>	4.5	1	17	30	_	38		
Output rise/fall time	$t_{TLH}$	4.5	_	5	15	_	19	ns	
	t <sub>THL</sub>								
Input capacitance	Cin	_	_	5	10	_	10	pF	

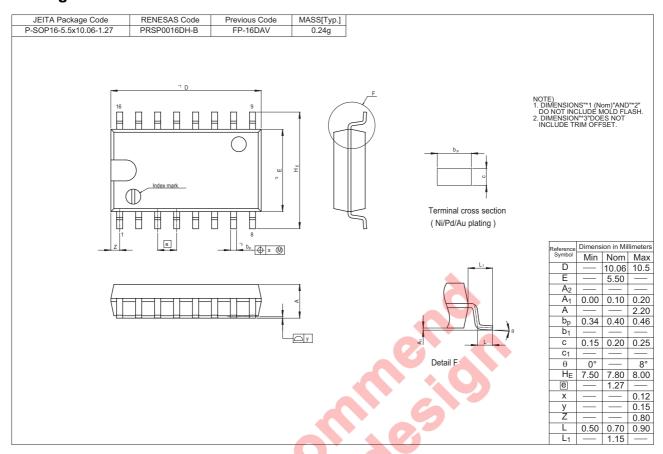
### **Test Circuit**

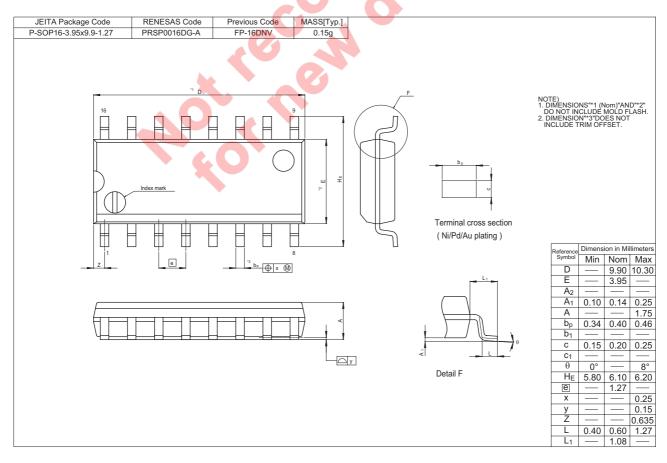


#### **Waveforms**



#### **Package Dimensions**





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